

# X4-Class Power MOSFET™

# IXTK400N15X4 IXTX400N15X4

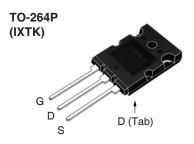
N-Channel Enhancement Mode Avalanche Rated

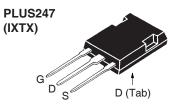


Symbol	Test Conditions	Maximum Ratings		
V <sub>DSS</sub>	$T_J$ = 25°C to 175°C	150	V	
V <sub>DGR</sub>	$T_J$ = 25°C to 175°C, $R_{GS}$ = 1M $\Omega$	150	V	
V <sub>GSS</sub>	Continuous	± 20	V	
V <sub>GSM</sub>	Transient	± 30	V	
I <sub>D25</sub> I <sub>L(RMS)</sub>	$T_{\rm C}=25^{\circ}{\rm C}$ (Chip Capability)	400	A	
	External Lead Current Limit	160	A	
	$T_{\rm C}=25^{\circ}{\rm C}$ , Pulse Width Limited by $T_{\rm JM}$	900	A	
I <sub>A</sub>	T <sub>c</sub> = 25°C	200	A	
E <sub>AS</sub>	T <sub>c</sub> = 25°C	3	J	
P <sub>D</sub>	T <sub>C</sub> = 25°C	1500	W	
dv/dt	$I_{_{S}} \le I_{_{DM}}, V_{_{DD}} \le V_{_{DSS}}, T_{_{J}} \le 150^{\circ}C$	50	V/ns	
T <sub>J</sub>		-55 +175	°C	
T <sub>JM</sub>		175	°C	
T <sub>stg</sub>		-55 +175	°C	
T <sub>L</sub>	Maximum Lead Temperature for Soldering 1.6 mm (0.062in.) from Case for 10s	300	°C	
T <sub>SOLD</sub>		260	°C	
M <sub>d</sub>	Mounting Torque (TO-264)	1.13/10	Nm/lb.in	
F <sub>c</sub>	Mounting Force (PLUS247)	20120 /4.527	N/lb	
Weight	TO-264	10	g	
	PLUS247	6	g	

		cteristic Values Typ.   Max.			
BV <sub>DSS</sub>	$V_{GS} = 0V, I_D = 1mA$	150			V
$V_{\rm GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 1mA$	2.5		4.5	V
I <sub>GSS</sub>	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 200	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 15$	0°C		25 2	μA mA
R <sub>DS(on)</sub>	$V_{GS} = 10V, I_{D} = 100A, Note 1$		2.4	3.1	mΩ

150V 400A  $3.1 m\Omega$  $\mathbf{R}_{\mathrm{DS(on)}}$ 





G = Gate D = Drain S = SourceTab = Drain

## **Features**

- International Standard Packages
- Low Q<sub>G</sub>
  Avalanche Rated
- Low Package Inductance

# **Advantages**

- High Power Density
- Easy to Mount
- Space Savings

### **Applications**

- Switch-Mode and Resonant-Mode **Power Supplies**
- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- Robotics and Servo Controls



Symbol Test Conditions		Chai	haracteristic Values		
$(T_J = 25^{\circ}C, U)$	Inless Otherwise Specified)	Min.	Тур.	Max	
g <sub>fs</sub>	$V_{DS} = 10V, I_{D} = 60A, Note 1$	100	170	S	
$R_{Gi}$	Gate Input Resistance		1.2	Ω	
C <sub>iss</sub>			14.5	nF	
C <sub>oss</sub>	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		3.1	nF	
C <sub>rss</sub>			8.0	pF	
	Effective Output Capacitance				
$C_{o(er)}$	Energy related $\bigvee_{GS} = 0V$		2500	pF	
$C_{o(tr)}$	Time related $\int_{DS} V_{DS}^{GS} = 0.8 \cdot V_{DSS}$		9400	pF	
t <sub>d(on)</sub>			40	ns	
t,	Resistive Switching Times		22	ns	
t <sub>d(off)</sub>	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		180	ns	
t <sub>f</sub>	$R_{\rm G} = 1\Omega$ (External)		8	ns	
Q <sub>g(on)</sub>			430	nC	
Q <sub>gs</sub>	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		100	nC	
$Q_{gd}$			100	nC	
R <sub>thJC</sub>				0.10 °C/W	
R <sub>thcs</sub>			0.15	°C/W	

#### Source-Drain Diode

Symbo	ol Test Conditions (	Characteristic Values		
$(T_{J} = 2)$	5°C, Unless Otherwise Specified) Min	n. Typ.	Max.	
Is	$V_{gs} = 0V$		400	Α
I <sub>SM</sub>	Repetitive, Pulse Width Limited by $T_{_{ m JM}}$		1600	Α
V <sub>SD</sub>	$I_F = 100A$ , $V_{GS} = 0V$ , Note 1		1.4	V
t <sub>rr</sub>	$I_{\rm F} = 150$ A, -di/dt = 100A/ $\mu$ s	175		ns
$\mathbf{Q}_{_{\mathrm{RM}}}$	} '	1.1		μC
I <sub>RM</sub>	$\int V_{R} = 100V, V_{GS} = 0V$	12.3		Α

Note 1. Pulse test,  $t \le 300\mu s$ , duty cycle,  $d \le 2\%$ .



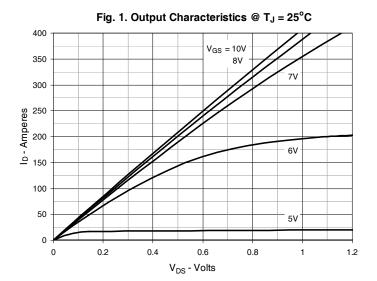
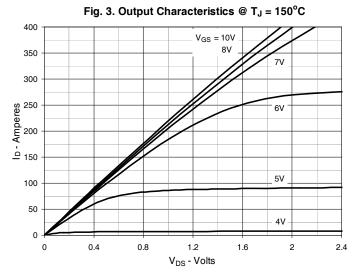
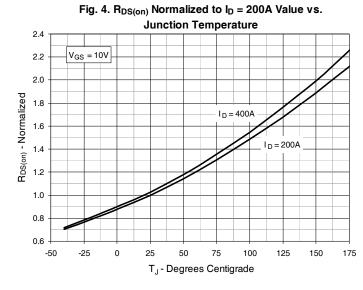
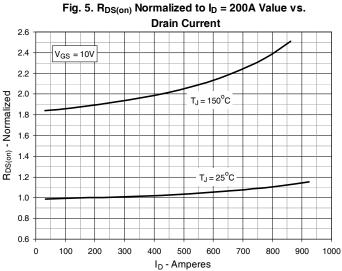
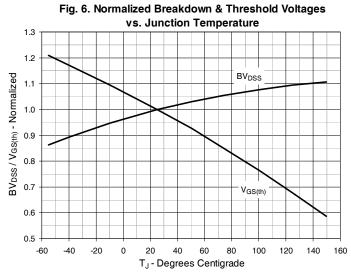


Fig. 2. Extended Output Characteristics @ T<sub>J</sub> = 25°C 1000 V<sub>GS</sub> = 10V 9V 900 8V 800 700 Ip - Amperes 600 500 400 300 200 100 5V 2 3 6 0 5 10 V<sub>DS</sub> - Volts









F: F B N II I 1 1 0004 V I

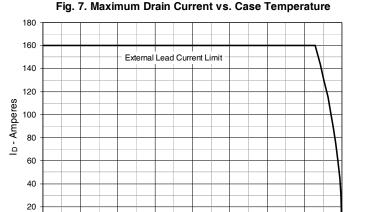


0

-50

-25

0



50

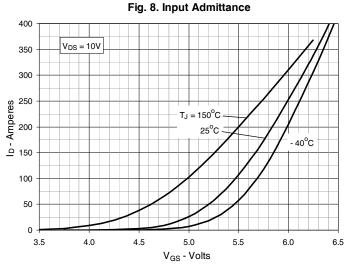
T<sub>C</sub> - Degrees Centigrade

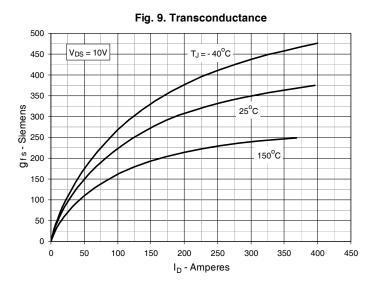
75

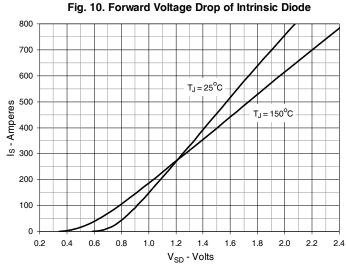
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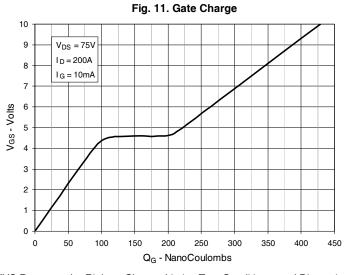
125

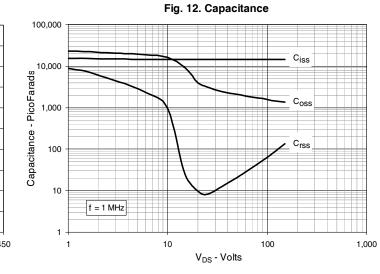
150











 $\ensuremath{\mathsf{IXYS}}$  Reserves the Right to Change Limits, Test Conditions, and Dimensions.



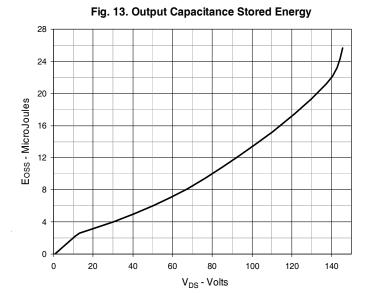


Fig. 14. Forward-Bias Safe Operating Area

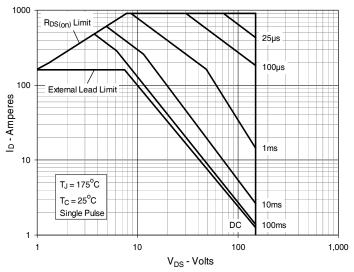
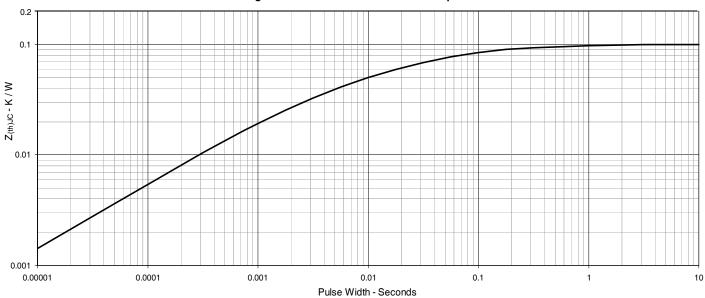
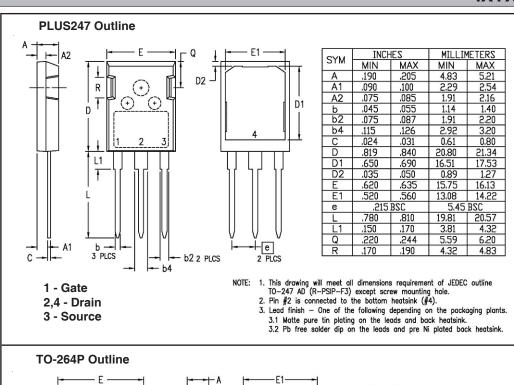
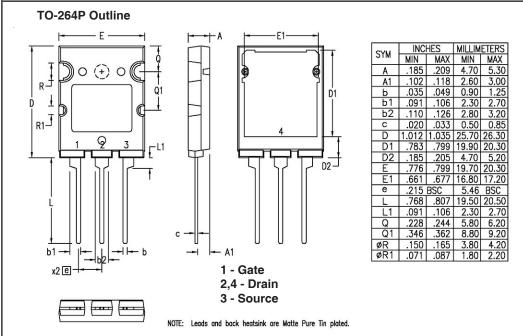


Fig. 15. Maximum Transient Thermal Impedance













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